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Complementary Bias Resistor Transistors R1 = 2.2 k Ω , R2 = ∞ k Ω

NPN and PNP Transistors with Monolithic Bias Resistor Network

This series of digital transistors is designed to replace a single device and its external resistor bias network. The Bias Resistor Transistor (BRT) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base–emitter resistor. The BRT eliminates these individual components by integrating them into a single device. The use of a BRT can reduce both system cost and board space.

Features

- S and NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

(T_A = 25°C both polarities Q1 (PNP) and Q2 (NPN), unless otherwise noted)

Rating	Symbol	Max	Unit	
Collector-Base Voltage	V _{CBO}	50	Vdc	
Collector-Emitter Voltage	V _{CEO}	50	Vdc	
Collector Current – Continuous	Ι _C	100	mAdc	
Input Forward Voltage	V _{IN(fwd)}	12	Vdc	
Input Reverse Voltage –NPN –PNP	V _{IN(rev)}	6 5	Vdc	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ORDERING INFORMATION

Device	Package	Shipping [†]
NSBC123TPDP6T5G	SOT-963	8,000 / Tape & Reel

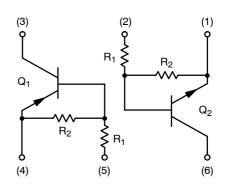
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



ON Semiconductor®

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PIN CONNECTIONS



MARKING DIAGRAMS



A M SOT-963 CASE 527AD



- = Date Code*
- = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation may vary depending upon manufacturing location.

THERMAL CHARACTERISTICS

Characteristic		Symbol	Max	Unit			
NSBC123TPDP6 (SOT-963) One Junction Heated							
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	(Note 1) (Note 2) (Note 1) (Note 2)	PD	231 269 1.9 2.2	mW mW/°C			
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{ hetaJA}$	540 464	°C/W			
NSBC123TPDP6 (SOT-963) Both Junction Heated (Note 3)							
Total Device Dissipation $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	(Note 1) (Note 2) (Note 1) (Note 2)	PD	339 408 2.7 3.3	mW mW/°C			
Thermal Resistance, Junction to Ambient	(Note 1) (Note 2)	$R_{ hetaJA}$	369 306	°C/W			

T_J, T_{stg}

-55 to +150

°C

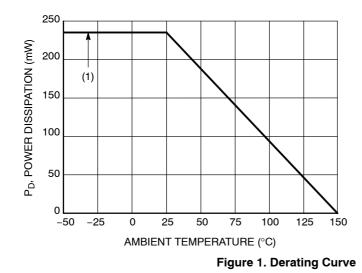
Junction and Storage Temperature Range

FR-4 @ 100 mm², 1 oz. copper traces, still air.
 FR-4 @ 500 mm², 1 oz. copper traces, still air.
 Both junction heated values assume total power is sum of two equally powered channels.

ELECTRICAL CHARACTERISTICS	(T _A	= 25°C both polarities Q	1 (F	PNP) and Q ₂	(NPN), unless otherwise noted)
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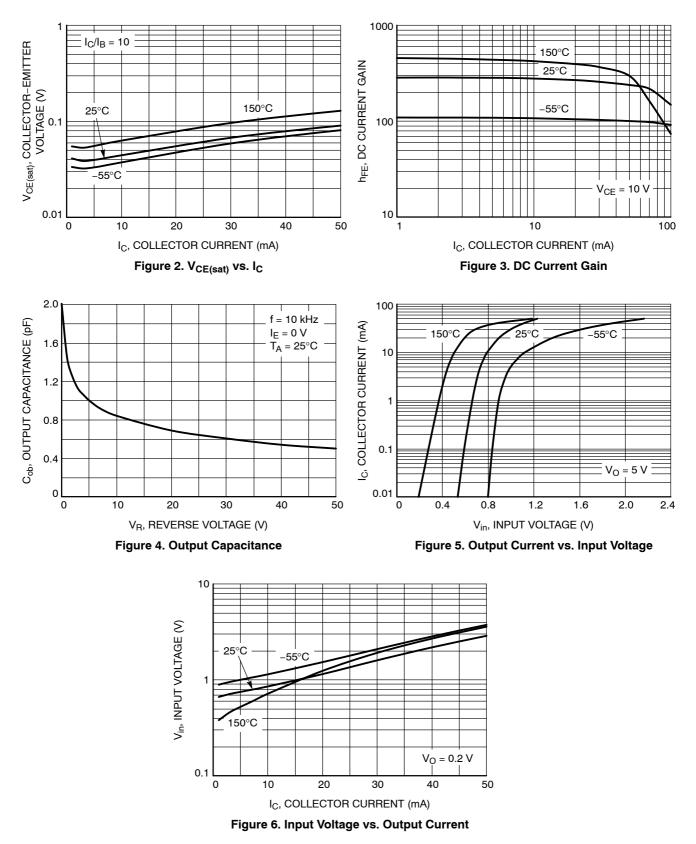
Characteristic	Symbol	Min	Тур	Max	Unit	
OFF CHARACTERISTICS						
Collector-Base Cutoff Current $(V_{CB} = 50 \text{ V}, I_E = 0)$	I _{CBO}	-	_	100	nAdc	
Collector–Emitter Cutoff Current $(V_{CE} = 50 \text{ V}, I_B = 0)$	I _{CEO}	_	_	500	nAdc	
Emitter-Base Cutoff Current $(V_{EB} = 6.0 \text{ V}, I_C = 0)$	I _{EBO}	_	_	4.0	mAdc	
Collector-Base Breakdown Voltage $(I_{C} = 10 \ \mu A, I_{E} = 0)$	V _(BR) CBO	50	_	-	Vdc	
Collector–Emitter Breakdown Voltage (Note 4) $(I_{C} = 2.0 \text{ mA}, I_{B} = 0)$	V _(BR) CEO	50	-	-	Vdc	
ON CHARACTERISTICS						
DC Current Gain (Note 4) (I _C = 5.0 mA, V _{CE} = 10 V)	h _{FE}	160	350	-		
Collector–Emitter Saturation Voltage (Note 4) $(I_C = 10 \text{ mA}, I_B = 1.0 \text{ mA})$	V _{CE(sat)}	-	_	0.25	Vdc	
Input Voltage (off) $(V_{CE} = 5.0 \text{ V}, I_{C} = 100 \mu\text{A}) \text{ (NPN)}$ $(V_{CE} = 5.0 \text{ V}, I_{C} = 100 \mu\text{A}) \text{ (PNP)}$	V _{i(off)}		0.6 0.6		Vdc	
Input Voltage (on) ($V_{CE} = 0.2 \text{ V}, I_C = 10 \text{ mA}$) (NPN) ($V_{CE} = 0.2 \text{ V}, I_C = 10 \text{ mA}$) (PNP)	V _{i(on)}		0.9 0.9		Vdc	
Output Voltage (on) (V _{CC} = 5.0 V, V _B = 2.5 V, R _L = 1.0 k Ω)	V _{OL}	-	-	0.2	Vdc	
Output Voltage (off) (V _{CC} = 5.0 V, V _B = 0.25 V, R _L = 1.0 k Ω)	V _{OH}	4.9	_	-	Vdc	
Input Resistor	R1	1.5	2.2	2.9	kΩ	
Resistor Ratio	R ₁ /R ₂	-	-	-		

4. Pulsed Condition: Pulse Width = 300 msec, Duty Cycle $\leq 2\%$.

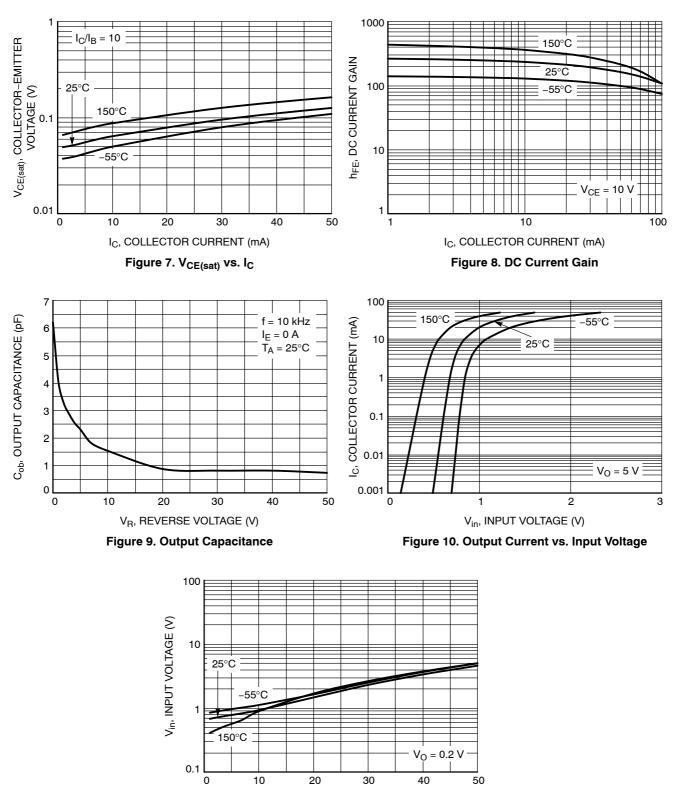


(1) SOT-963; 100 mm², 1 oz. copper trace

TYPICAL CHARACTERISTICS – NPN TRANSISTOR NSBC123TPDP6



TYPICAL CHARACTERISTICS – PNP TRANSISTOR NSBC123TPDP6



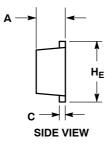
I_C, COLLECTOR CURRENT (mA)

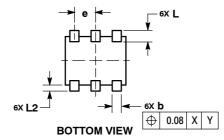
Figure 11. Input Voltage vs. Output Current

PACKAGE DIMENSIONS

SOT-963 CASE 527AD ISSUE E

TOP VIEW





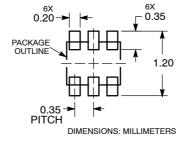
NOTES: 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

2. CONTROLLING DIMENSION: MILLIMETERS 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF

BASE MATERIAL.
DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MILLIMETERS				
DIM	MIN	NOM	MAX		
Α	0.34	0.37	0.40		
b	0.10	0.15	0.20		
С	0.07	0.12	0.17		
D	0.95	1.00	1.05		
Е	0.75	0.80	0.85		
е	0.35 BSC				
HE	0.95	1.00 1.0			
Г	0.19 REF				
L2	0.05	0.10	0.15		

RECOMMENDED MOUNTING FOOTPRINT



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